DuPont™ EKC922™ universal photoresist remover is an organic based photoresist remover formulated to remove positive and negative photoresist and other organic compounds where an ultra clean surface is required.

**EKC922™ Advantages:**
- No phenol or chlorinated solvents
- Extended bath life
- Compatible with III to V compound semiconductors (i.e., GaAs, InP and SiGe)
- Safe to use on semi-cured polyimides
- Compatible with conventional semiconductor materials

**Typical Applications for EKC922™:**
- Bulk photoresist removal for
  - MEMS
  - Backlap process
  - Chrome photomasks
  - Metal carriers
  - Ink dot removal
  - Integrated circuits
  - Hybrid device
  - III–V compound semiconductors
  - Spinner parts

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**Before/After Photos:**
- **After DuPont™ EKC922™/85°C/30 min**
- **After DuPont™ EKC922™/85°C/15 min**
- **After etch**
- **After etch**
For more information on DuPont® EKC922™ universal photoresist remover or other DuPont EKC Technology products, please contact your local representative, or visit our website:

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